506190541 08/06/2020

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6237280

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
ALEXANDROS MANOLAKOS	04/13/2020
ALEXANDER DOROSENCO	04/13/2020
JAY KING	04/13/2020
JOSEPH BINAMIRA SORIAGA	05/10/2020
JOSEPH PATRICK BURKE	05/15/2020

RECEIVING PARTY DATA

Name:	QUALCOMM INCORPORATED
Street Address:	5775 MOREHOUSE DRIVE
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121-1714

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16795338

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Email: meo.docket@mg-ip.com

Correspondent Name: MUNCY, GEISSLER, OLDS & LOWE, P.C./QC

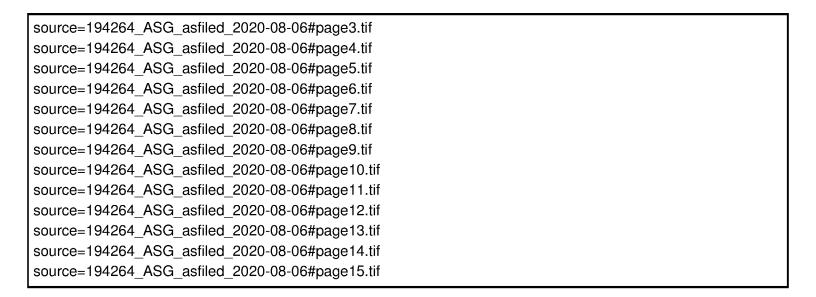
Address Line 1: 4000 LEGATO ROAD, SUITE 310

Address Line 4: FAIRFAX, VIRGINIA 22033

ATTORNEY DOCKET NUMBER:	QC194264
NAME OF SUBMITTER:	RENEE ELDER
SIGNATURE:	/Renee Elder/
DATE SIGNED:	08/06/2020

Total Attachments: 15

source=194264_ASG_asfiled_2020-08-06#page1.tif source=194264_ASG_asfiled_2020-08-06#page2.tif



WHEREAS, WE.

- 1. Alexandros MANOLAKOS, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,
- 2. Alexander DOROSENCO, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,
- 3. Jay KING, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,
- 4. Joseph Binamira SORIAGA, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,
- 5. Joseph Patrick BURKE, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to BEAM-SPECIFIC GROUP DELAY / FREQUENCY LOOKUP TABLE SIGNALING FOR HIGH-PRECISION MULTI-ROUND-TRIP-TIME (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 16/795,338 filed February 19, 2020, Qualcomm Reference Number 194264, and all provisional applications relating thereto, together with Greek Application No(s). 20190100390, filed September 10, 2019, Qualcomm Reference Number 194264GR1, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at _		(A 04/13/2020) JANUAROS
Done at	City, State	Date , on	Átexandros MANOLAKOS
	City, State	Date	Alexander DOROSENCO
Done at_	City, State	on	Jay KING
Done at_	City, State	on	Joseph Binamira SORIAGA
Done at _	City, State	on	Joseph Patrick BURKE

WHEREAS, WE.

- 1. Alexandros MANOLAKOS, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,
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WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 16/795,338 filed February 19, 2020, Qualcomm Reference Number 194264, and all provisional applications relating thereto, together with Greek Application No(s). 20190100390, filed September 10, 2019, Qualcomm Reference Number 194264GR1, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have

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AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries:

Date of the second second				
100		Airennin	******	A BARRO
Date				
Cay Name		Aircontra	000000	98 83
		Jan KING		
	470200			
		Acceptable		er.

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AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at _	, on		
	City, State	Date	Alexandros MANOLAKOS
Done at _	, on		
	City, State	Date	Alexander DOROSENCO
Done at <u>≨</u>	City, State	4/13/2020 Date	Jay KING
Done at _	, on _	Date	Joseph Binamira SORIAGA
Done at _			
	City, State	Date	Joseph Patrick BURKE

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AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at Gan Diego, CA, on Date Alexandros MANOLAKOS

Done at Ser Diego, CA, on O4/13/2029
City, State Date Alexander DOROSENCO

Done at _____, on ____
City, State Date Jay KING

Done at ____, on ____
City, State Date Joseph Binamira SORIAGA

Done at ____, on ____
City, State Date Joseph Patrick BURKE

WHEREAS, WE,

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Qualcomm Reference Number: 194264
Page 3 of 3

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Done at	, on		
	City, State	Date	Alexandros MANOLAKOS
Done at	, on		
	City, State	Date	Alexander DOROSENCO
Done at	, on		
•	City, State	Date	Jay KING
Done at	, on		
	City, State	Date	Joseph Binamira SORIAGA
Done at	SLEAVIEW, IL, on	5/15/20	
	City State	Date	Joseph-Patrick BURKE

PATENT REEL: 053416 FRAME: 0254

RECORDED: 08/06/2020